

Electronic Acknowledgement Receipt

EFS ID:	1063589
Application Number:	10596139
Confirmation Number:	2702
Title of Invention:	RESIN COMPOSITION, MOLDED PRODUCT OBTAINED FROM RESIN COMPOSITION AND METHOD FOR PREPARATION OF RESIN COMPOSITION
First Named Inventor:	Shinichiro Yamada
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Attorney Docket Number:	09792909-6492
Receipt Date:	01-JUN-2006
Filing Date:	
Time Stamp:	11:35:56
Application Type:	U.S. National Stage under 35 USC 371
International Application Number:	PCT/JP04/17729

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
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1		Sony_6492_Spec.pdf	234122	yes	68
	Multipart Description				
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	Claims		64	67	
	Abstract		68	68	
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2	Documents submitted with 371 Applications	Sony_6492_PCT_Req.pdf	167287	no	7
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3	Foreign Reference	Sony_6492_IDS_Ref1.pdf	902700	no	16
Warnings:					
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4	Foreign Reference	Sony_6492_IDS_Ref2.pdf	296786	no	8
Warnings:					
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5	Foreign Reference	Sony_6492_IDS_Ref3.pdf	1459332	no	25
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6	NPL Documents	Sony_6492_ISR_NPL.pdf	60477	no	1
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Information:					
7	Information Disclosure Statement (IDS) Filed	Sony_6492_US_IDS_Form_SB_08a.pdf	924395	no	4
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8	Information Disclosure Statement (IDS) Filed	Sony_6492_IDS.pdf	68184	no	1
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9	Documents submitted with 371 Applications	Sony_6492_Req_Exam.pdf	64974	no	1
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10	Fee Worksheet (PTO-875)	fee-info.pdf	8621	no	2
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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.